

Thermal Flowable Gap Putty multicomp^{PRO}

RoHS
Compliant



Description

Formable gap putty (FGP) work by being dispensed into the available gap. When applied to an irregular surface between the heat source and heat sink, the material will stay in the required area. This improves contact between the surfaces, completely filling air gaps and voids and thereby increasing heat transfer.

Features

- No flowing when set
- Maintains superior contact with components
- Convenient for usage
- High thermal conductivity

Applications

- Communications equipment
- Automotive electronics
- Mainframe and small office networking
- Cooling modules

Properties

Characteristic	Value	Test Method
Colour	White	Visual
Thermal Conductivity	2W/mK	ISO 22007-2
Thermal Impedance	0.06°C-in ² /W	ASTM-D5470
Operation Temperature	-40°C to +200°C	EN344
Extrusion Rate g/min	30g/min	-

Part Number Table

Description	Part Number
Thermal Flowable Gap Putty, White, 2W/mK, 30ml	MPGCS-020-FGP-30cc

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